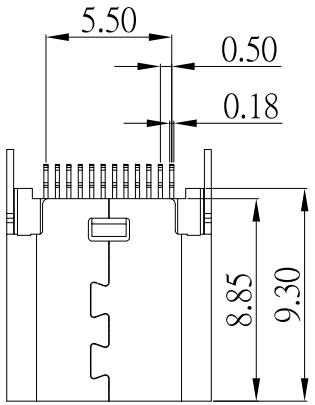
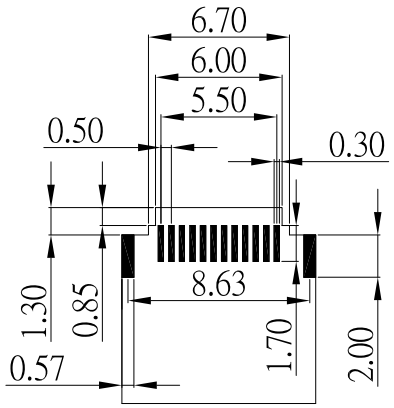




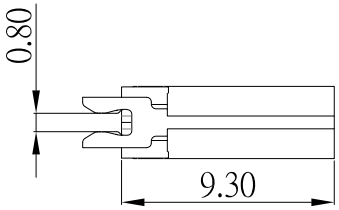


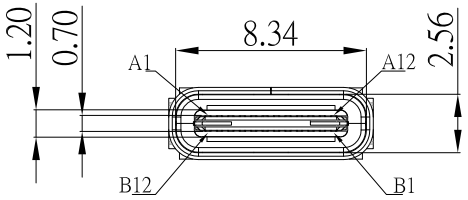
PCB LAYOUT

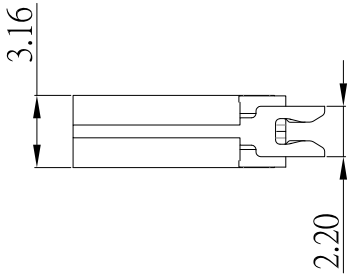
SBC-240V4-31x-S271

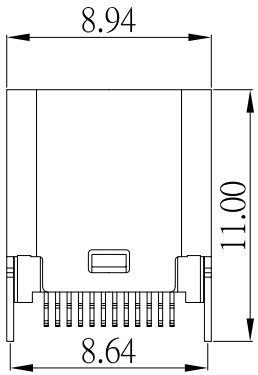
鍍層厚度 :

Blank : 1u"
2 : 15u"
3 : 30u"









SPECIFICATIONS

Electrical:

1.Rating: 3.0 A

2.Dielectric Withstand Voltage: 100V AC

3.Contact Resistance: 40 mΩ Max

4.Insulation Resistance: 100 MΩ Min

Material:

1.Housing: LCP,UL 94V-0

2.Contact: C1814

3.Shell: SUS

Finish:

1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall

2.Shell: Nickel under Plated surface layer

ITEM NO.	DESCRIPTION	DRAWN	DATE
2	更新Contact材質	Jack	011223
1	新增pcb layout	Jack	081617

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2; Above 5 ~ 15 ±0.3; Above 15 ~ 30 ±0.4; Above 30 ~ 50 ±0.5; Angle ±0.3°

3RD. ANGEL'S | UNITS MM

		DATE
DRAWN BY:	Jack Lu	01/12/23
CHECKED BY:	Jacky Chen	01/12/23
APPROVED BY:	Tony Kao	01/12/23

MAT'L		TITLE	CONNECTOR
FINISH		MODLE	USB 3.1 TYPE C 夾板母座
SCALE	1 : 1	DWG NO.	SBC-240V4-31x-S271
SHEET NO.	1 of 1	PART NO.	SBC-240V4-31x-S271

SIZE A4 | VER R2